

## Low Quiescent Current, PFM/PWM Synchronous Boost Regulator with True Output Disconnect or Input/Output Bypass Option

### ■ General Description

The SMD215 is a compact, high-efficiency, fixed frequency, synchronous step-up DC-DC converter. This family of devices provides an easy-to-use power supply solution for applications powered by either one-cell, two-cell or three-cell alkaline, NiCd, NiMH, one-cell Li-Ion or Li-Polymer batteries. A low-voltage technology allows the regulator to start up without high inrush current or output voltage overshoot from a low voltage input. High efficiency is accomplished by integrating the low-resistance N-Channel boost switch and synchronous P-Channel switch. All compensation and protection circuitry are integrated to minimize external components. SMD215 operates and consumes less than 14  $\mu\text{A}$  from battery, while operating at no load ( $V_{\text{OUT}} = 3.3\text{V}$ ,  $V_{\text{IN}} = 1.5\text{V}$ ). The devices provide a true disconnect from input to output (SMD215AE) or an input-to-output bypass (SMD215BE), while in shutdown ( $\text{EN} = \text{GND}$ ). Both options consume less than  $0.6\mu\text{A}$  from battery. Output voltage is set by a small external resistor divider.

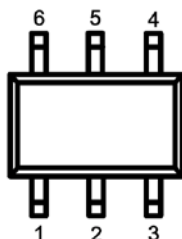
### ■ Applications

- One, Two and Three Cell Alkaline and NiMH/NiCd Portable Products
- Solar Cell Applications
- Personal Care and Medical Products
- Bias for Status LEDs
- Smartphones, MP3 Players, Digital Cameras
- Remote controllers, Portable Instruments
- Wireless Sensors
- Bluetooth Headsets
- +3.3V to +5.0V Distributed Power Supply

### ■ Features

- Up to 96% Typical Efficiency
- 1.0A Typical Peak Input Current Limit:
  - $I_{\text{OUT}} > 200\text{mA}$  @  $3.3\text{V } V_{\text{OUT}}$ ,  $1.2\text{V } V_{\text{IN}}$
  - $I_{\text{OUT}} > 400\text{mA}$  @  $3.3\text{V } V_{\text{OUT}}$ ,  $2.4\text{V } V_{\text{IN}}$
  - $I_{\text{OUT}} > 400\text{mA}$  @  $5.0\text{V } V_{\text{OUT}}$ ,  $3.3\text{V } V_{\text{IN}}$
- Low Device Quiescent Current:
  - Output Quiescent Current:  $< 4\mu\text{A}$  typical, device is not switching ( $V_{\text{OUT}} > V_{\text{IN}}$ , excluding feedback divider current)
  - Input Sleep Current:  $1\mu\text{A}$
  - No Load Input Current:  $14\mu\text{A}$  typical
- Shutdown Current:  $0.6\mu\text{A}$  typical
- Low Start-up Voltage:  $0.82\text{V}$ ,  $1\text{mA}$  load
- Low Operating Input Voltage: down to  $0.65\text{V}$
- Adjustable Output Voltage Range:  $2.2\text{V}$  to  $5.5\text{V}$
- Maximum Input Voltage  $\leq V_{\text{OUT}} < 5.5\text{V}$
- Automatic PFM/PWM Operation:
  - PWM Operation:  $500\text{KHz}$
  - PFM Output Ripple:  $150\text{mV}$  typical
- Feedback voltage:  $1.215\text{V}$
- Internal Synchronous Rectifier
- Internal Compensation
- Inrush Current Limiting and Internal Soft Start ( $1\text{ms}$  typical)
- Selectable, Logic Controlled, Shutdown States:
  - True Load Disconnect Option (SMD215AE)
  - Input to Output Bypass Option (SMD215BE)
- Anti-Ringing Control
- Over temperature Protection
- Output Short Protection
- Available Packages:
  - SOT-23-6

## ■ PIN CONFIGURATION



SMD215①②

DESIGNATOR	SYMBOL	DESCRIPTION
①	A	Disconnect option
	B	Bypass option
②	E/ER	Package: SOT-23-6

PIN NO.		PIN NAME	FUNCTION
E	ER		
1	1	SW	Switch Node, Boost Inductor Input Pin
2	2	GND	Ground Pin
3	4	V <sub>FB</sub>	Feedback Voltage Pin
4	3	EN	Enable Control Input Pin
5	5	V <sub>OUT</sub>	Output Voltage Pin
6	6	V <sub>IN</sub>	Input Voltage Pin

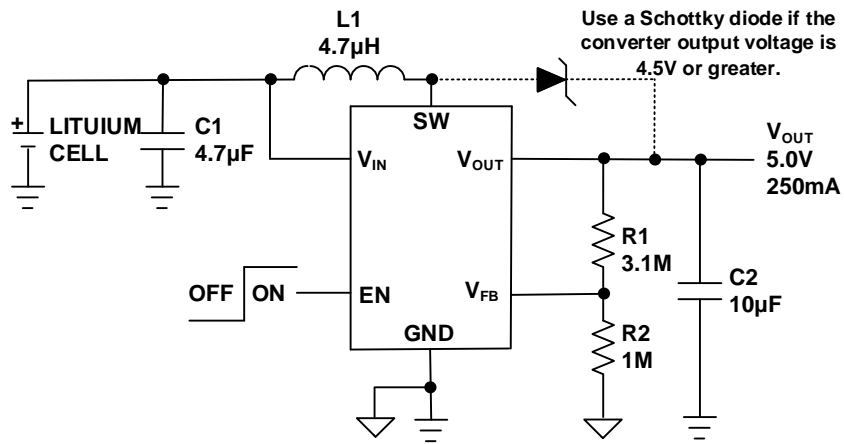
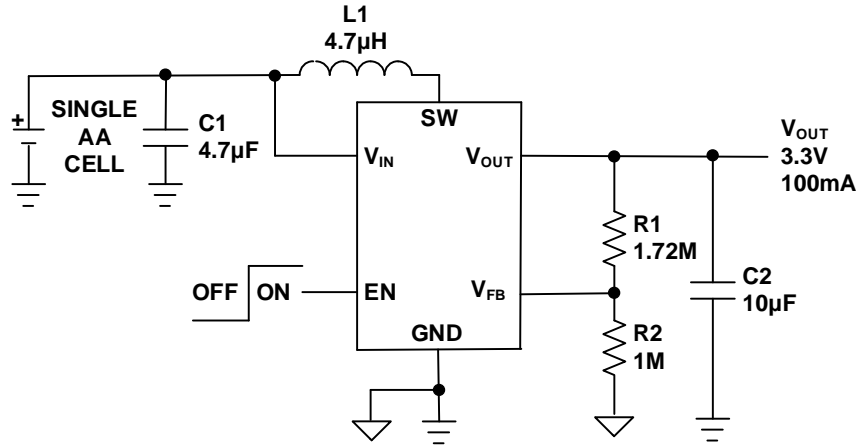
## ■ ABSOLUTE MAXIMUM RATINGS

(T<sub>A</sub> = 25°C, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNITS
Input Voltage	V <sub>IN</sub>	-0.3 ~ 6	V
SW Voltage		-0.3 ~ 6	V
CE, FB Voltage		-0.3 ~ 6	V
Output Voltage	V <sub>OUT</sub>	-0.3 ~ 6	V
Output Current Bypass Mode		1000	mA
Power dissipation	PD	Internally Limited	mW
Ambient Temp. with Power Applied	T <sub>opr</sub>	-40 ~ +85	°C
Storage Temperature Range	T <sub>stg</sub>	-55 ~ +150	°C
Lead Temperature (Soldering, 10 sec)	T <sub>solder</sub>	260	°C
ESD rating	Human Body Model-(HBM)	≥ 2	KV
	Machine Model-(MM)	≥ 200	V

**Note:** Stresses above those listed under “Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

## ■ Typical Application



## ■ ELECTRICAL CHARACTERISTICS

(Unless otherwise indicated,  $V_{IN} = 1.5V$ ,  $C_{OUT} = C_{IN} = 10\mu F$ ,  $L = 4.7\mu H$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT} = 0mA$ ,  $T_A = +25^\circ C$ . Boldface specifications apply over the  $T_A$  range of  $-40^\circ C$  to  $+85^\circ C$ .)

Parameters	Sym	Min	Typ	Max	Units	Conditions
Minimum Start-Up Voltage	$V_{IN}$	—	0.82	—	V	Note1
Minimum Input Voltage After Start-Up	$V_{IN}$	—	0.65	—	V	Note1
Input Voltage range	$V_{IN}$	0.82		5.5	V	
Output Voltage Adjust Range	$V_{OUT}$	2.2		5.5	V	$V_{OUT} \geq V_{IN}$ ; Note2
Maximum Output Current	$I_{OUT}$		200	—	mA	1.2V $V_{IN}$ , 3.3V $V_{OUT}$
			400	—		2.4V $V_{IN}$ , 3.3V $V_{OUT}$
			400	—		3.3V $V_{IN}$ , 5.0V $V_{OUT}$
Feedback Voltage	$V_{FB}$	1.179	1.215	1.251	V	
Feedback Input Bias Current	$I_{VFB}$	—	10	—	nA	
$V_{OUT}$ Quiescent Current	$I_{QOUT}$	—	4.0	8	$\mu A$	$I_{OUT} = 0mA$ , device is not switching, $EN = V_{IN} = 4.0V$ , $V_{OUT} = 5.0V$ , does not include feedback divider current; Note3
$V_{IN}$ Sleep Current	$I_{QIN}$	—	1.0	2.3	$\mu A$	$I_{OUT} = 0mA$ , $EN = V_{IN}$ Note3, Note5
No Load Input Current	$I_{IN0}$	—	14	25	$\mu A$	$I_{OUT} = 0mA$ , device is switching
Quiescent Current – Shutdown	$I_{QSHDN}$	—	0.6	—	$\mu A$	$V_{OUT} = EN = GND$ ; includes N-Channel and P-Channel Switch Leakage

### Note :

1. 3.3k $\Omega$  resistive load, 3.3V $_{OUT}$  (1mA).
2. For  $V_{IN} > V_{OUT}$ ,  $V_{OUT}$  will not remain in regulation.
3.  $I_{QOUT}$  is measured at  $V_{OUT}$ ,  $V_{OUT}$  is external supplied for  $V_{OUT} > V_{IN}$  (device is not switching),  $I_{QIN}$  is measured at  $V_{IN}$  pin during Sleep period, no load.
4. 220 $\Omega$  resistive load, 3.3V $_{OUT}$  (15mA).
5. Determined by characterization, not production tested.

## ■ ELECTRICAL CHARACTERISTICS (CONTINUED)

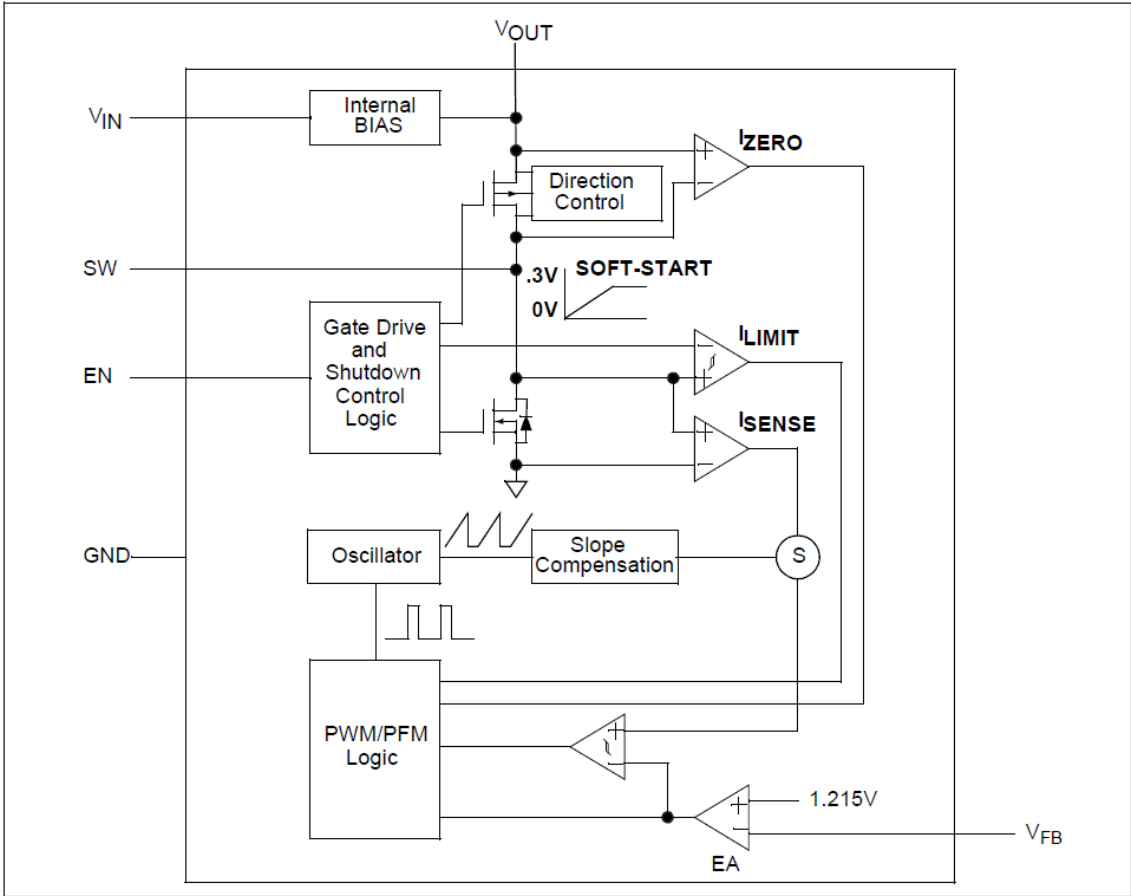
(Unless otherwise indicated,  $V_{IN} = 1.5V$ ,  $C_{OUT} = C_{IN} = 10\mu F$ ,  $L = 4.7\mu H$ ,  $V_{OUT} = 3.3V$ ,  $I_{OUT} = 0mA$ ,  $T_A = +25^\circ C$ . Boldface specifications apply over the  $T_A$  range of  $-40^\circ C$  to  $+85^\circ C$ .)

Parameters	Sym	Min	Typ	Max	Units	Conditions
NMOS Switch Leakage	$I_{NLK}$	—	0.15	—	$\mu A$	$V_{IN} = V_{SW} = 5V$ $V_{OUT} = 5.5V$ $V_{EN} = V_{FB} = GND$
PMOS Switch Leakage	$I_{PLK}$	—	0.15	—	$\mu A$	$V_{IN} = V_{SW} = GND$ ; $V_{OUT} = 5.5V$
NMOS Switch ON Resistance	$R_{DS(ON)N}$	—	0.25	—	$\Omega$	$V_{IN} = 3.3V$ , $I_{SW} = 100mA$
PMOS Switch ON Resistance	$R_{DS(ON)P}$	—	0.5	—	$\Omega$	$V_{IN} = 3.3V$ , $I_{SW} = 100mA$
NMOS Peak Switch Current Limit	$I_{N(MAX)}$	—	1	—	A	Note5
$V_{OUT}$ Accuracy	$V_{OUT\%}$	-3	—	+3	%	Includes Line and Load Regulation; $V_{IN} = 1.5V$
Line Regulation	$ \frac{\Delta V_{OUT}/V_{OUT}}{\Delta V_{IN}} $	-0.4	0.3	0.4	%/V	$V_{IN} = 1.5V$ to $2.8V$ $I_{OUT} = 50mA$
Load Regulation	$ \Delta V_{OUT}/V_{OUT} $	-1.5	0.1	1.5	%	$I_{OUT} = 25mA$ to $100mA$ ; $V_{IN} = 1.5V$
Maximum Duty Cycle	$DC_{MAX}$	87	89	91	%	Note5
Switching Frequency	$f_{SW}$		500		KHz	
EN Input Logic High	$V_{IH}$	70	—	—	% of $V_{IN}$	$I_{OUT} = 1mA$
EN Input Logic Low	$V_{IL}$	—	—	20	% of $V_{IN}$	$I_{OUT} = 1mA$
EN Input Leakage Current	$I_{ENLK}$	—	5.0	—	nA	$V_{EN} = 5V$
Soft Start Time	$t_{SS}$	—	1		ms	EN Low to High, 90% of $V_{OUT}$ ; Note4, Note5
Thermal Shutdown Die Temperature	$T_{SD}$	—	160	—	$^\circ C$	$I_{OUT} = 20mA$ , $V_{IN} > 1.4V$
Die Temperature Hysteresis	$T_{SDHYS}$	—	20	—	$^\circ C$	

### Note :

1. 3.3k $\Omega$  resistive load, 3.3V $_{OUT}$  (1mA).
2. For  $V_{IN} > V_{OUT}$ ,  $V_{OUT}$  will not remain in regulation.
3.  $I_{QOUT}$  is measured at  $V_{OUT}$ ,  $V_{OUT}$  is external supplied for  $V_{OUT} > V_{IN}$  (device is not switching),  $I_{QIN}$  is measured at  $V_{IN}$  pin during Sleep period, no load.
4. 220 $\Omega$  resistive load, 3.3V $_{OUT}$  (15mA).
5. Determined by characterization, not production tested.

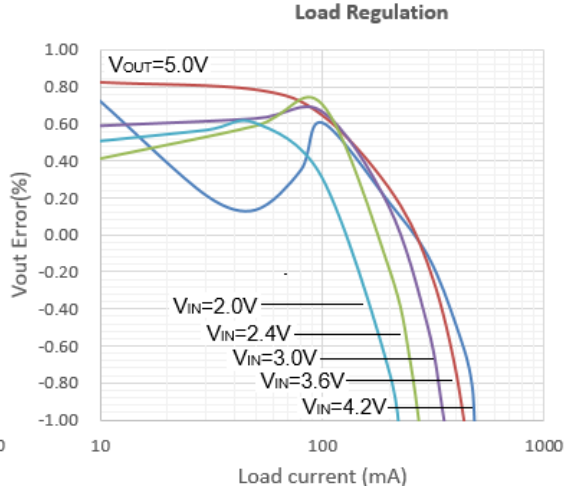
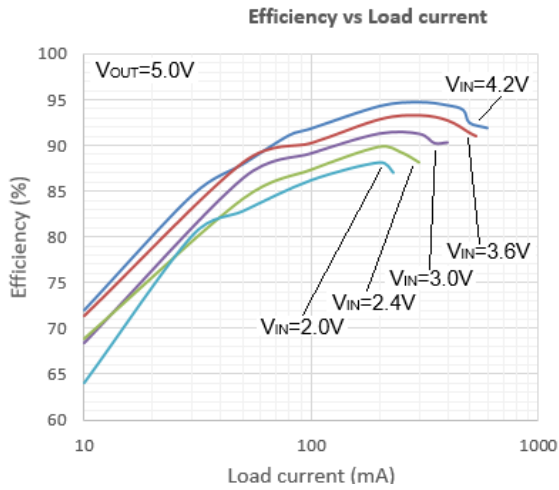
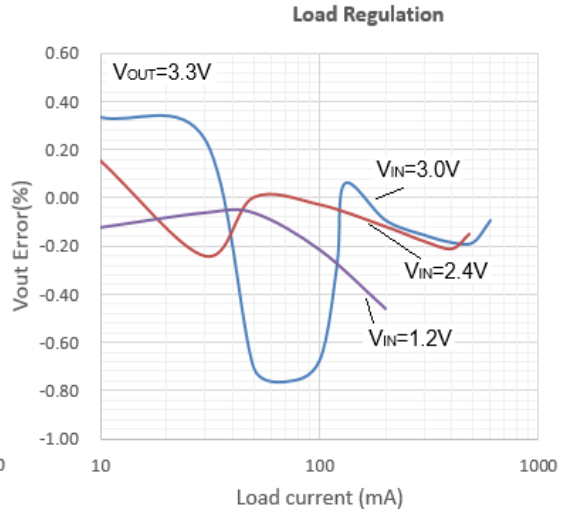
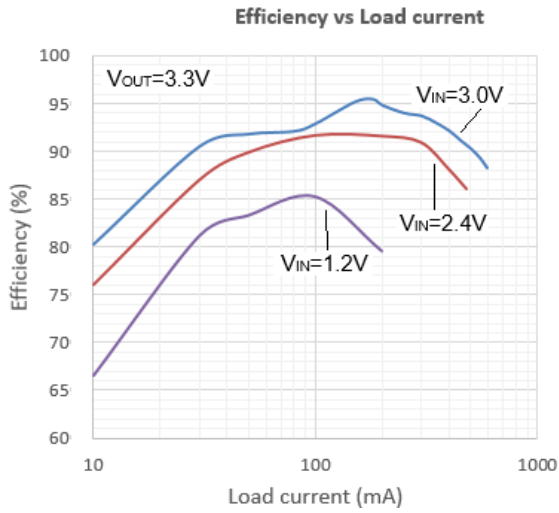
■ Functional Description



SMD215 Block Diagram

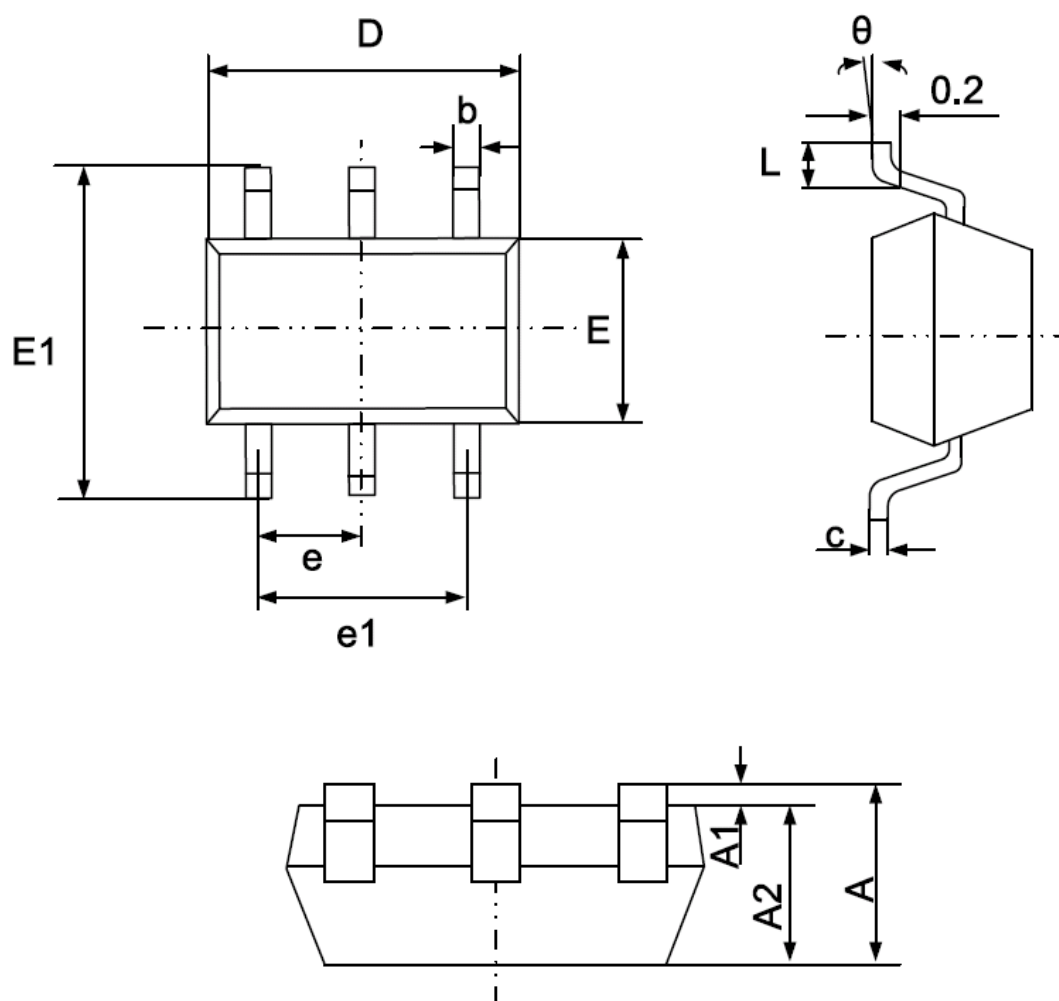
■ TYPICAL PERFORMANCE CHARACTERISTICS

( $T_A = 25^\circ\text{C}$ , unless otherwise specified)



## ■ PACKAGING INFORMATION

### ● SOT-23-6 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
$\theta$	0°	8°	0°	8°



© SMTES TECHNOLOGY PTE. LTD.

SMTES cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a SMTES product. No circuit patent license, copyrights or other intellectual property rights are implied. SMTES reserves the right to make changes to their products or specifications without notice. Customers are advised to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete.